

LOCTITE ABLESTIK 3280T

August 2012

PRODUCT DESCRIPTION

LOCTITE ABLESTIK 3280T provides the following product characteristics:

Technology	Acrylate
Appearance	Silver
Cure	Heat cure
Product Benefits	<ul style="list-style-type: none"> Improved MRT levels Good adhesion to Cu, Ag and PPF Snap curable Electrically conductive
Application	Die attach
Filler Type	Silver
pH	3.6
Substrates	Copper, Silver and PPF

LOCTITE ABLESTIK 3280T die attach adhesive is designed for high reliability packaging applications. It offers improved JEDEC performance on packages with die sizes <100 mil.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	≥4.0
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	9,000
Work Life @ 25°C, hours	24
Shelf Life @ °C (from date of manufacture), days	365

TYPICAL CURING PERFORMANCE
Cure Schedule

30 minute ramp to 175°C + 15 minutes @ 175°C in N₂
(Recommended oxygen levels is <1%)

Snap Cure Schedule

Zone #	1	2	3	4	5	6	7	Total Time
Temp °C	140	150	200	220	220	220	220	60 sec

Note: N₂ PreHeat Temp: 150°C

Weight Loss on Cure

10 x 10 mm Si die on glass slide, %	6.8
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The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL
Physical Properties

Coefficient of Thermal Expansion :	
Below T _g , ppm/°C	83

Above T _g , ppm/°C	165
Glass Transition Temperature, Tan Δ Max, °C	52
Tensile Modulus, DMTA :	
@ -65 °C	N/mm ² 6,337 (psi) (919,000)
@ 25 °C	N/mm ² 1,310 (psi) (191,000)
@ 150 °C	N/mm ² 121 (psi) (17,000)
@ 250 °C	N/mm ² 121 (psi) (17,000)

Extractable Ionic Content, @ 100°C ppm:

Chloride (Cl ⁻)	<20
Sodium (Na ⁺)	<15
Potassium (K ⁺)	<15

Water Extract Conductivity, μmhos/cm	18
Moisture Absorption @ Saturation, wt.% @ 0.2 85°C/85%RH	

Electrical Properties

Volume Resistivity, ohms-cm	0.003
Bond Joint Resistance, ohms	0.002

TYPICAL PERFORMANCE OF CURED MATERIAL
Miscellaneous

Die Shear Strength

2 X 2 mm Si die, kg-f,

Substrate	@25°C	@200°C	@250°C
Ag/Cu leadframe	6.2	2.2	1.9

5 X 5 mm Si die, kg-f,

Substrate	@25°C
Ag/Cu leadframe	11

Chip Warpage, μm

0.38 mm thick Si die on 0.2 mm thick Ag/Cu LF @ 25°C, μm

Chip Size:	Warpage:
7.6 x 7.6 mm	5.9
12.7 X 12.7 mm	23.6

GENERAL INFORMATION

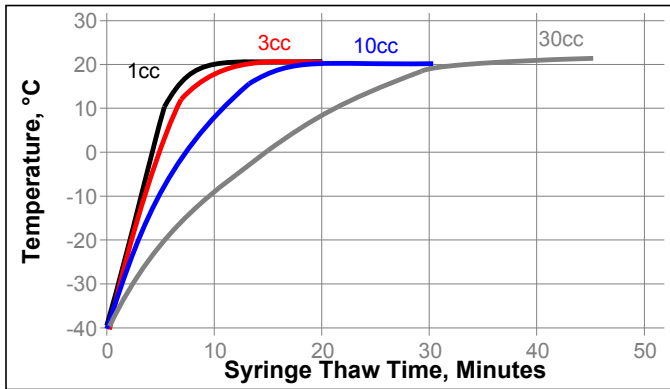
For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

THAWING:

1. Allow container to reach room temperature before use.
2. After removing from the freezer, set the syringes to stand vertically while thawing.
3. Refer to the Syringe Thaw time chart for the thaw time recommendation.
4. DO NOT open the container before contents reach 25°C

temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.

- DO NOT re-freeze. Once thawed to -40°C , the adhesive should not be re-frozen.



DIRECTIONS FOR USE

- Thawed adhesive should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- Adhesive must be completely used within the product's recommended work life.
- Silver-resin separation may occur if the adhesive is left out at room temperature, beyond the recommended work life.
- Apply enough adhesive to achieve a 25 to 50 μm wet bondline thickness, dispensed with approximately 25 to 50 % filleting on all sides of the die.
- Alternate dispense amounts may be used depending on the application requirements.
- Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40°C . Storage below minus ($-$) 40°C or greater than minus ($-$) 40°C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$
 $\text{kV/mm} \times 25.4 = \text{V/mil}$
 $\text{mm} / 25.4 = \text{inches}$
 $\text{N} \times 0.225 = \text{lb}$
 $\text{N/mm} \times 5.71 = \text{lb/in}$
 $\text{psi} \times 145 = \text{N/mm}^2$
 $\text{MPa} = \text{N/mm}^2$
 $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$
 $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$
 $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$
 $\text{mPa}\cdot\text{s} = \text{cP}$

Disclaimer

Note:

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